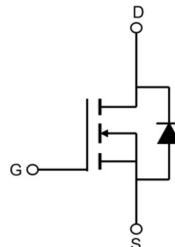


Description

Features <ul style="list-style-type: none"> ● 20V, 90A $R_{DS(ON)} < 4.0\text{m}\Omega$ @ $V_{GS} = 4.5\text{V}$ $R_{DS(ON)} < 6.0\text{m}\Omega$ @ $V_{GS} = 2.5\text{V}$ ● Lead free and Green Device Available ● Excellent $R_{DS(ON)}$ and Low Gate Charge ● Lead free product is acquired 	Application <ul style="list-style-type: none"> ● Load Switch ● PWM Application ● Power management <p style="text-align: center;">100% UIS 100% ΔV_{ds}</p>
 TO-252	

Package Marking and Ordering Information

Device Marking	Device	OUTLINE	Device Package	Reel Size	Reel (PCS)	Per Carton (PCS)
VSM90N02-T2	VSM90N02	TAPING	TO-252	13inch	2500	25000

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter		Max.	Units
V_{DSS}	Drain-Source Voltage		20	V
V_{GSS}	Gate-Source Voltage		± 12	V
I_D	Continuous Drain Current	$T_C = 25^\circ\text{C}$	90	A
		$T_C = 100^\circ\text{C}$	59	A
I_{DM}	Pulsed Drain Current ^{note1}		360	A
E_{AS}	Single Pulsed Avalanche Energy ^{note2}		110	mJ
P_D	Power Dissipation	$T_C = 25^\circ\text{C}$	81	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.85	$^\circ\text{C}/\text{W}$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +175	°C

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristic						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	20	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=20\text{V}$, $V_{GS}=0\text{V}$	-	-	1	μA
I_{GSS}	Gate to Body Leakage Current	$V_{GS}=\pm 12\text{V}$, $V_{DS}=0\text{V}$	-	-	± 100	nA
On Characteristics						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	0.4	0.7	1.0	V
$R_{DS(\text{on})}$ note3	Static Drain-Source On-Resistance	$V_{GS}=4.5\text{V}$, $I_D=30\text{A}$	-	2.8	4	$\text{m}\Omega$
		$V_{GS}=2.5\text{V}$, $I_D=20\text{A}$		4	6	
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=10\text{V}$, $V_{GS}=0\text{V}$, $f=1.0\text{MHz}$	-	3200	-	pF
C_{oss}	Output Capacitance		-	460	-	pF
C_{rss}	Reverse Transfer Capacitance		-	445	-	pF
Q_g	Total Gate Charge	$V_{DS}=10\text{V}$, $I_D=30\text{A}$, $V_{GS}=4.5\text{V}$	-	48	-	nC
Q_{gs}	Gate-Source Charge		-	3.6	-	nC
Q_{gd}	Gate-Drain("Miller") Charge		-	19	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	$V_{DS}=10\text{V}$, $I_D=30\text{A}$, $R_G=1.8\Omega$, $V_{GS}=4.5\text{V}$	-	9.7	-	ns
t_r	Turn-On Rise Time		-	37	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	63	-	ns
t_f	Turn-Off Fall Time		-	52	-	ns
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	90	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	360	A
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS}=0\text{V}$, $I_{SD}=30\text{A}$, $T_J=25^\circ\text{C}$	-	-	1.2	V
t_{rr}	Reverse Recovery Time	$T_J=25^\circ\text{C}$, $I_F=30\text{A}$, $dI/dt = 100\text{A}/\mu\text{s}$	-	23	-	ns
Q_{rr}	Reverse Recovery Charge		-	10	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition: $T_J=25^\circ\text{C}$, $V_{DD}=15\text{V}$, $V_G=4.5\text{V}$, $R_G=25\Omega$, $L=0.5\text{mH}$, $I_{AS}=21\text{A}$

3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$

Typical Performance Characteristics

Figure1: Output Characteristics

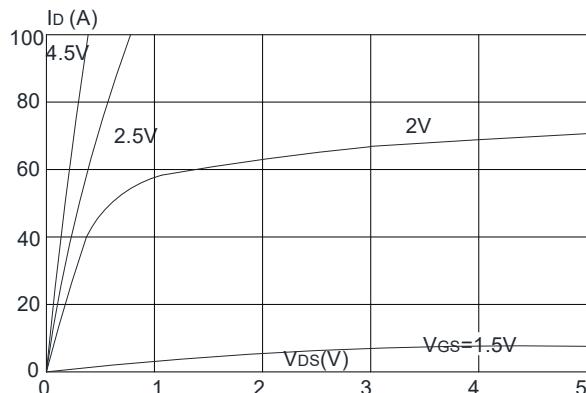


Figure 3: On-resistance vs. Drain Current

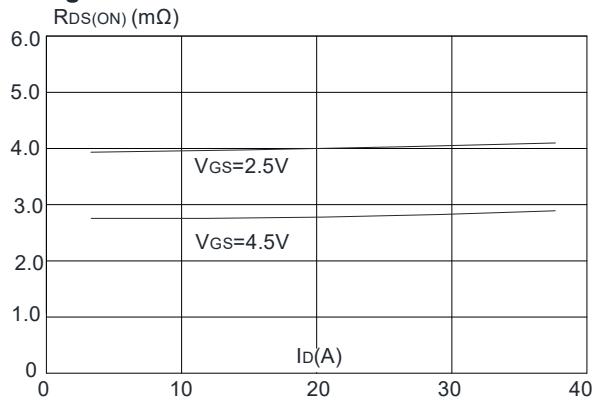


Figure 5: Gate Charge Characteristics

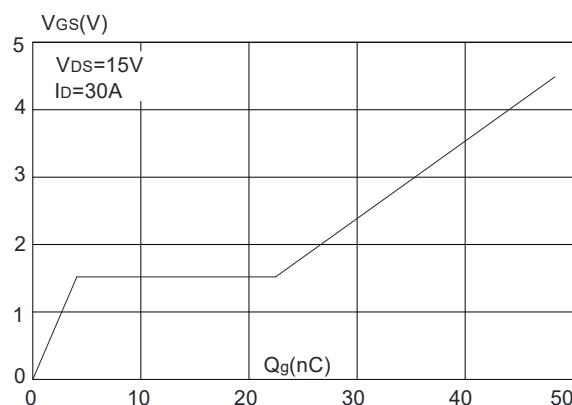


Figure 2: Typical Transfer Characteristics

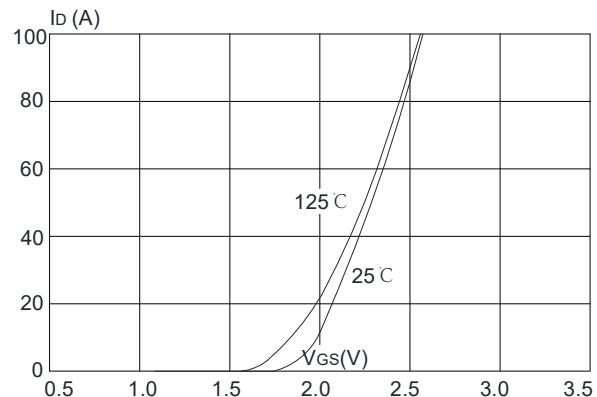


Figure 4: Body Diode Characteristics

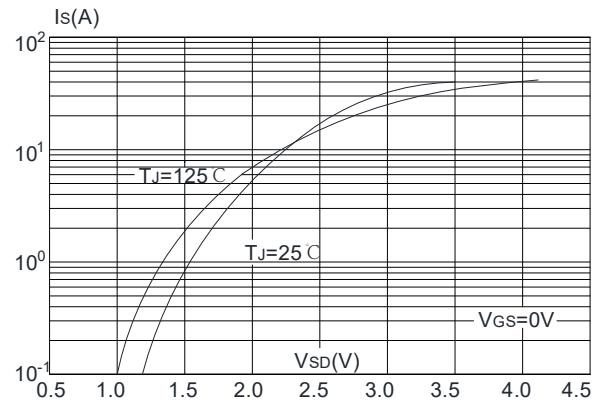


Figure 6: Capacitance Characteristics

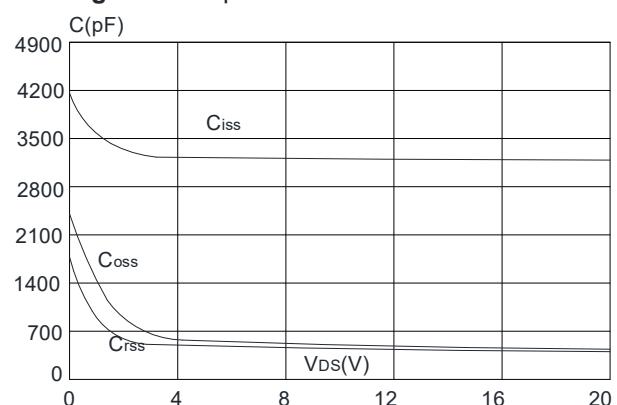


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

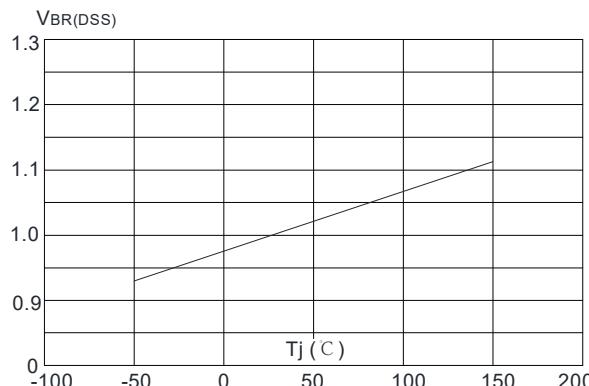


Figure 9: Maximum Safe Operating Area

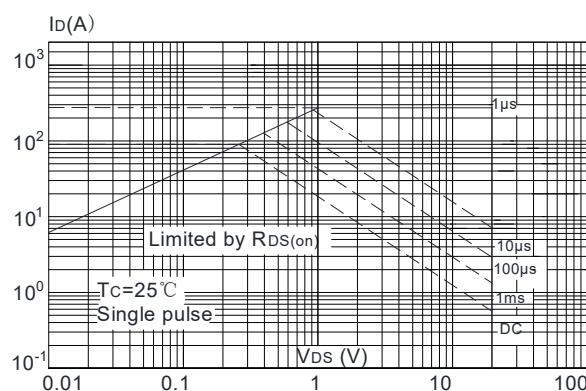


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

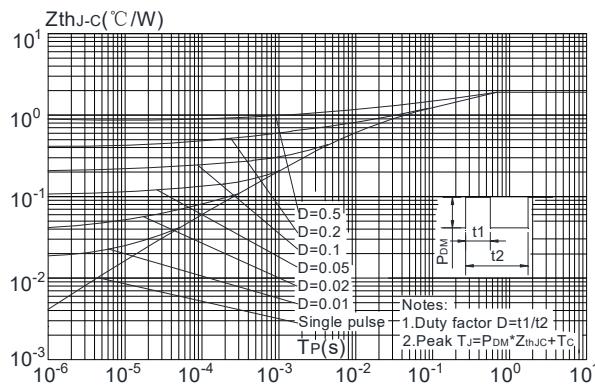


Figure 8: Normalized on Resistance vs. Junction Temperature

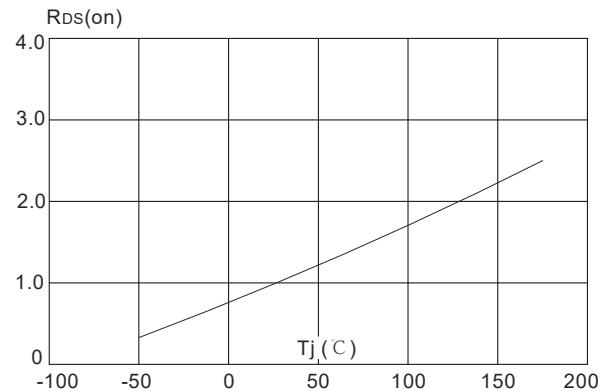
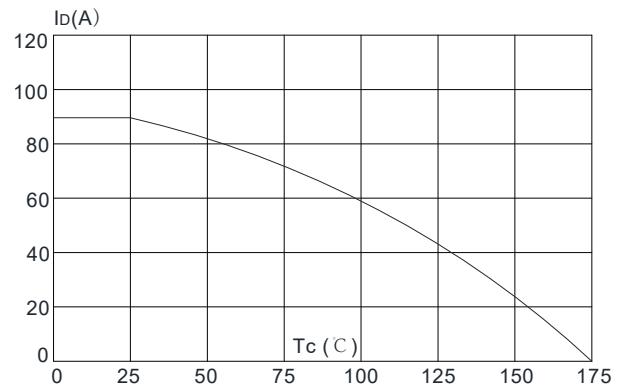


Figure 10: Maximum Continuous Drain Current vs. Case Temperature



Test Circuit

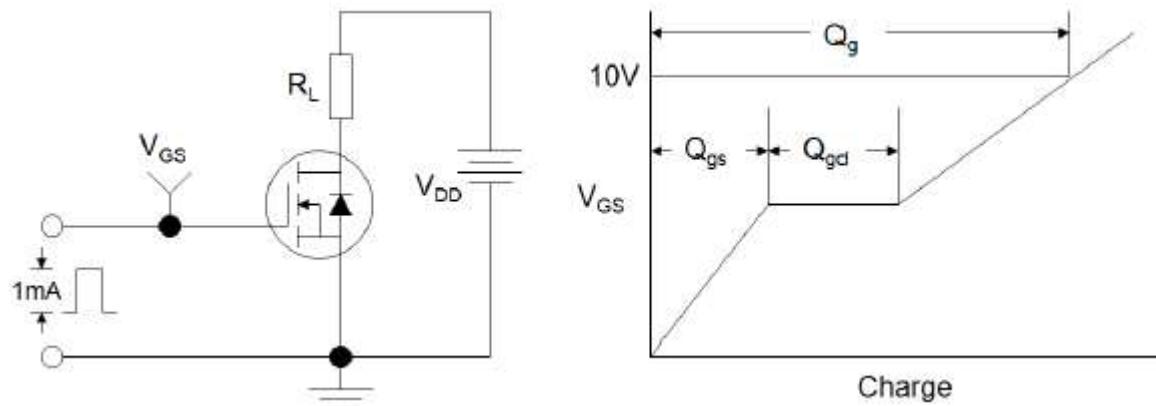


Figure1:Gate Charge Test Circuit & Waveform

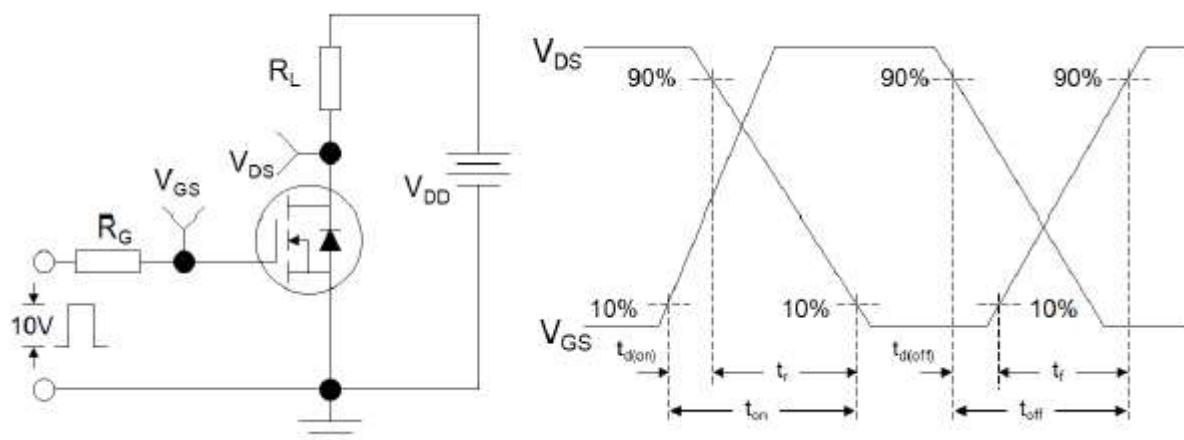


Figure 2: Resistive Switching Test Circuit & Waveforms

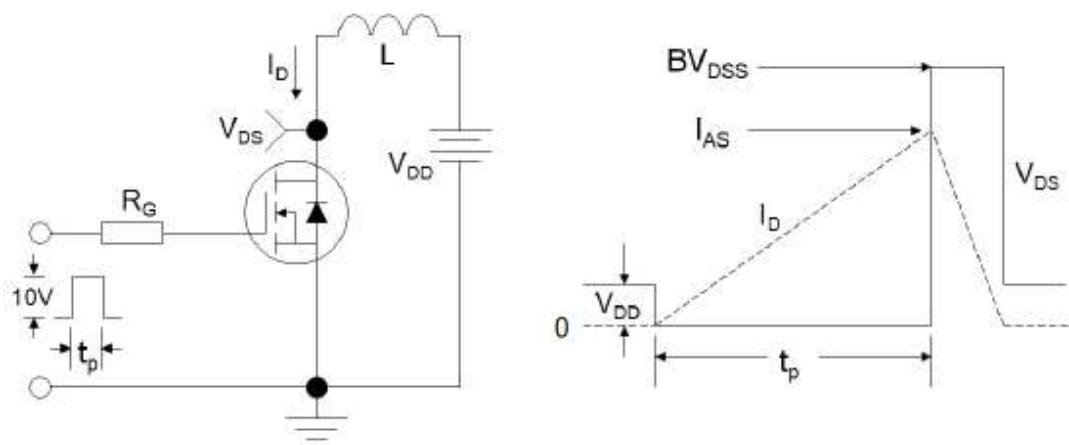


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms